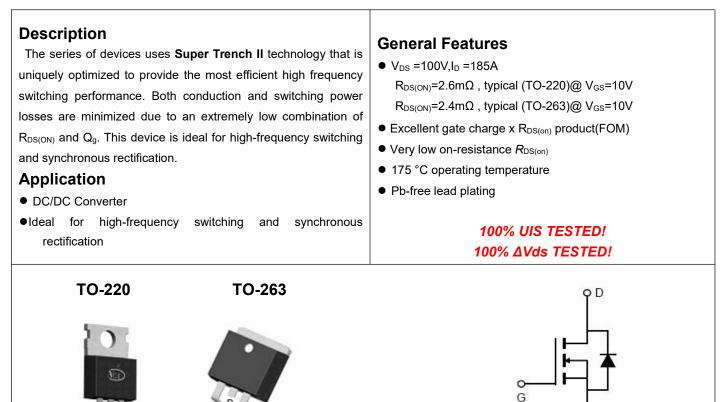


Schematic Diagram

NCE N-Channel Super Trench II Power MOSFET



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity	
NCEP029N10	NCEP029N10	TO-220	-	-	-	
NCEP029N10D	NCEP029N10D	TO-263	-	-	-	

Absolute Maximum Ratings (Tc=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	100	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous(Tc=25℃)	ID	185	A
Drain Current-Continuous(Tc=100 ℃)	I _D (100℃)	130	А
Pulsed Drain Current (Tc=25°C)	I _{DM}	740	А
Maximum Power Dissipation(T_c=25 $^{\circ}$ C)	PD	275	W
Derating factor		1.83	W/℃
Single pulse avalanche energy (Note 1)	E _{AS}	1692	mJ
Operating Junction and Storage Temperature Range	TJ,TSTG	-55 To 175	°C



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0.55

 $R_{\theta JC}$

Thermal Characteristic

Thermal Resistance, Junction-to-Case

°C/W

Electrical Characteristics (Tc=25 $^\circ\!\!\mathrm{C}$ unless otherwise noted)

Parameter	Symbol	Conditio	n	Min	Тур	Мах	Unit
Off Characteristics							
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA		100		-	V
Zero Gate Voltage Drain Current	IDSS	V _{DS} =100V,V _{GS} =0V		-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V		-	-	±100	nA
On Characteristics							,
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =2	50µA	2.0	3.0	4.0	V
Ducia October Ducistance	Rds(ON)	V _{GS} =10V, I _D =92.5A	TO-220	-	2.6	2.9	mΩ
Drain-Source On-State Resistance			TO-263		2.4	2.9	mΩ
Gate resistance	R _G			-	1.9	-	Ω
Forward Transconductance	G FS	V _{DS} =5V,I _D =92.5A		90	-	-	S
Dynamic Characteristics							
Input Capacitance	Clss	- V _{DS} =50V,V _{GS} =0V, - F=1.0MHz		-	13700	-	PF
Output Capacitance	Coss			-	1050	-	PF
Reverse Transfer Capacitance	Crss			-	41	-	PF
Switching Characteristics (Note 2)							
Turn-on Delay Time	t _{d(on)}			-	34	-	nS
Turn-on Rise Time	tr	V _{DD} =50V,I _D =92.5A V _{GS} =10V,R _G =1.6Ω		-	38	-	nS
Turn-Off Delay Time	t _{d(off)}			-	84	-	nS
Turn-Off Fall Time	t _f			-	28	-	nS
Total Gate Charge	Qg	- V _{DS} =50V,I _D =92.5A, - V _{GS} =10V		-	185	-	nC
Gate-Source Charge	Q _{gs}			-	54		nC
Gate-Drain Charge	Q _{gd}			-	48		nC
Drain-Source Diode Characteristics	·			•			
Diode Forward Voltage	V _{SD}	V _{GS} =0V,I _S =92.5A		-		1.2	V
Diode Forward Current	Is			-	-	185	Α
Reverse Recovery Time	t _{rr}	T _J = 25°C, I _F = 185A		-	86	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs		-	210	-	nC

Notes:

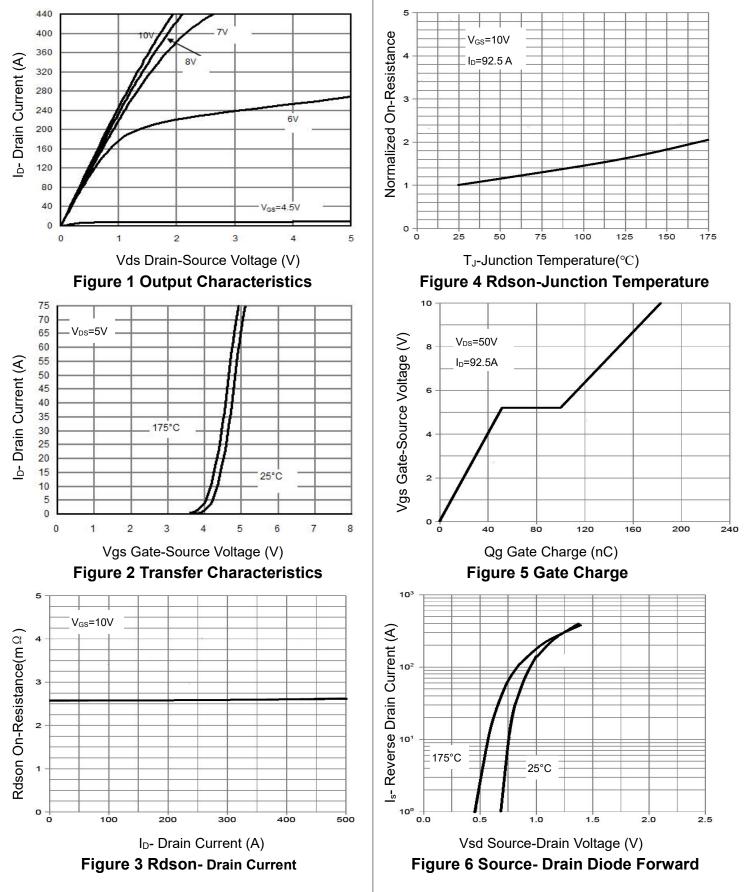
1. EAS condition : Tj=25 $^\circ \!\! \mathbb{C}$,V_{DD}=50V,V_G=10V,L=0.5mH,Rg=25\Omega

2. Guaranteed by design, not subject to production

3. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsin k, assuming a maximum junction temperature of TJ(MAX)=175° C. The SOA curve provides a single pulse rating.

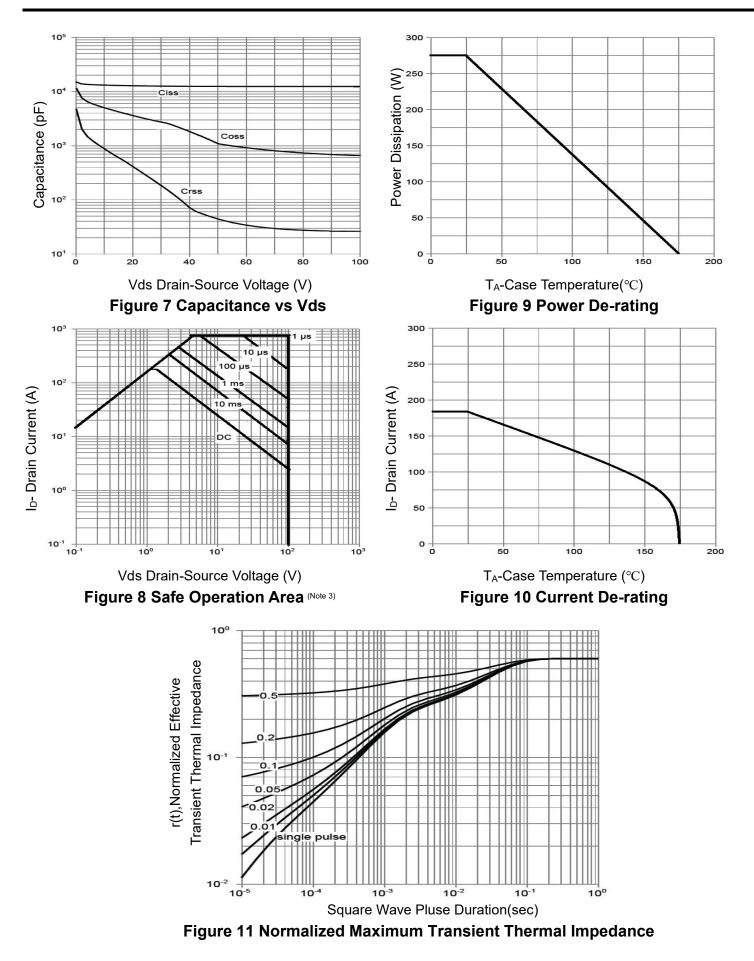


Typical Electrical and Thermal Characteristics



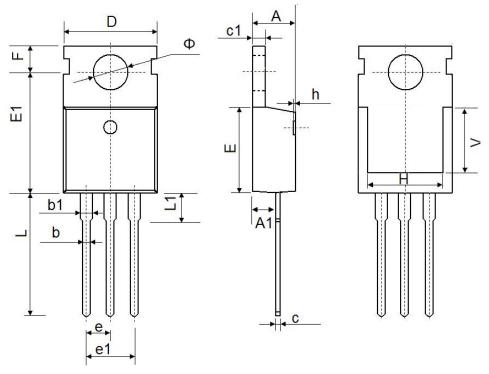


NCEP029N10, NCEP029N10D





TO-220-3L Package Information

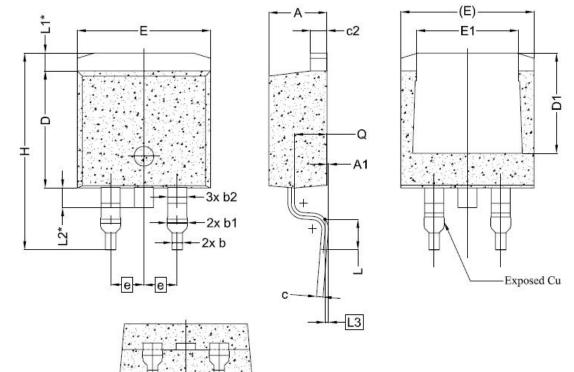


Symbol	Dimensions I	n Millimeters	Dimensions In Inches			
Symbol	Min.	Max.	Min.	Max.		
A	4.400	4.600	0.173	0.181		
A1	2.250	2.550	0.089	0.100		
b	0.710	0.910	0.028	0.036		
b1	1.170	1.370	0.046	0.054		
с	0.330	0.650	0.013	0.026		
c1	1.200	1.400	0.047	0.055		
D	9.910	10.250	0.390	0.404		
E	8.9500	9.750	0.352	0.384		
E1	12.650	12.950	0.498	0.510		
е	2.540	2.540 TYP.		0.100 TYP.		
e1	4.980	5.180	0.196	0.204		
F	2.650	2.950	0.104	0.116		
Н	7.900	8.100	0.311	0.319		
h	0.000	0.300	0.000	0.012		
L	12.900	13.400	0.508	0.528		
L1	2.850	3.250	0.112	0.128		
V	6.900 REF.		0.276 REF.			
Φ	3.400	3.800	0.134	0.150		



NCEP029N10, NCEP029N10D

TO-263-2L Package Information



Sumbal	Dimensions In Millimeters				
Symbol	Min.	Nom.	Max.		
A	4.24	4.44	4.64		
A1	0.00	0.10	0.25		
b	0.70	0.80	0.90		
b1	1.20	1.55	1.75		
b2	1.20	1.45	1.70		
с	0.40	0.50	0.60		
c2	1.15	1.27	1.40		
D	8.82	8.92	9.02		
D1	6.86	7.65	-		
E	9.96	10.16	10.36		
E1	6.89	7.77	7.89		
e	2.54BSC				
Н	14.61	15.00	15.88		
L	1.78	2.32	2.79		
L1	1.36 REF.				
L2	1.50 REF.				
L3	0.25 BSC				
Q	2.30	2.48	2.70		



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